



MOTOROLA INC.

*Communications
Sector*

FINAL POWER AMPLIFIER DECK

MODEL TLD2740A

(146-174 MHz)

1. GENERAL

The final power amplifier (FPA) is designed for continuous duty operation over the full -30°C to +60°C range of ambient temperatures. The amplifier employs ceramic hybrid modules with 50-ohm interfaces between all stages. Figure 1 shows a typical Final Power Amplifier Deck.

2. THEORY OF OPERATION

2.1 The input signal to the FPA comes from the DPA. Under nominal operating conditions, the input level of the FPA is 10 to 15 watts. This rf signal is divided into two 3-way splitters. The 6-way split signal is applied to six final amplifier modules. The combined outputs of the modules deliver 350 to 410 watts to the output connector. A directional coupler/power detector for power control and sensing output power is mounted on the combiner board.

2.2 Isolation resistors (TRN5207A, 7065A) under the splitter and combiner boards minimize the interaction between modules. In the event of a module failure or degradation, the resulting mismatch will be isolated from the other modules.

2.3 Operating temperature of the FPA is sensed by thermistor RT601 located on the dc distribution board. The thermistor senses the temperature on the heat sink backplane. The temperature information is used by the power control circuit to control the station power output under elevated ambient temperature.

3. SERVICING

3.1 GENERAL

3.1.1 Repair of the microstrip ceramic substrates is not recommended and should be avoided. The modules are built, tuned and tested at the factory employing special fixtures and processes to ensure proper operation.

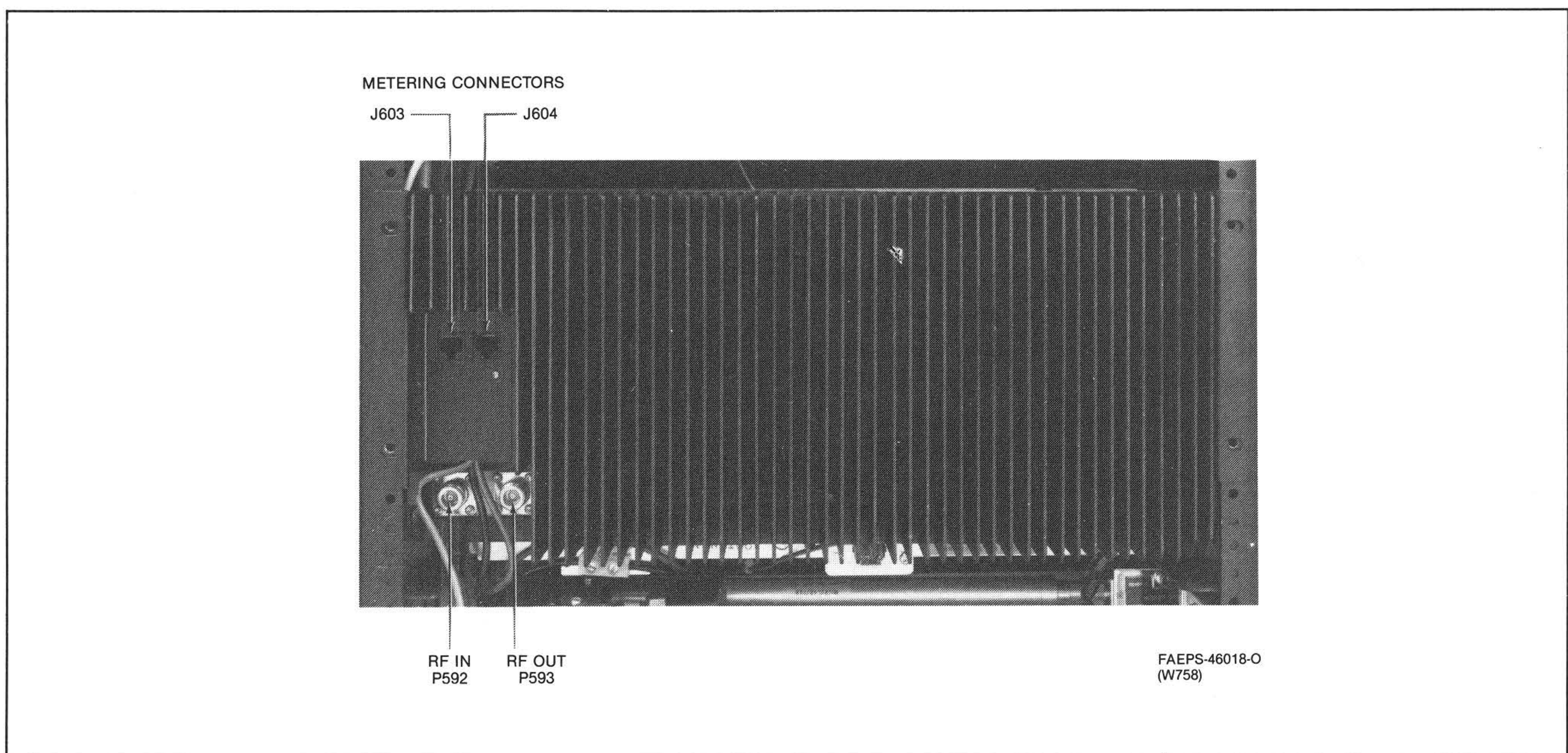


Figure 1. Front View of Final Power Amplifier Deck

technical writing services

1301 E. Algonquin Road, Schaumburg, IL 60196

12/30/89-PHI

68P81082E91-O

The repair procedure consists of replacing a defective module rather than components on the module.

IMPORTANT

All four cover screws must be tight to ensure optimum performance.

3.1.2 During servicing of the transmitter, it may be necessary to defeat the transmitter shutdown section of the power control. Under normal operation, the transmitter shutdown circuit signals the station control to turn off the transmitter when power control cannot level power. Transmitter shutdown can be prevented by installation of the service jumper JU1, on the Station Control board. This allows the serviceman to make measurements in the areas of power control, IPA, and both power amplifier decks regardless of conditions in the transmitter.

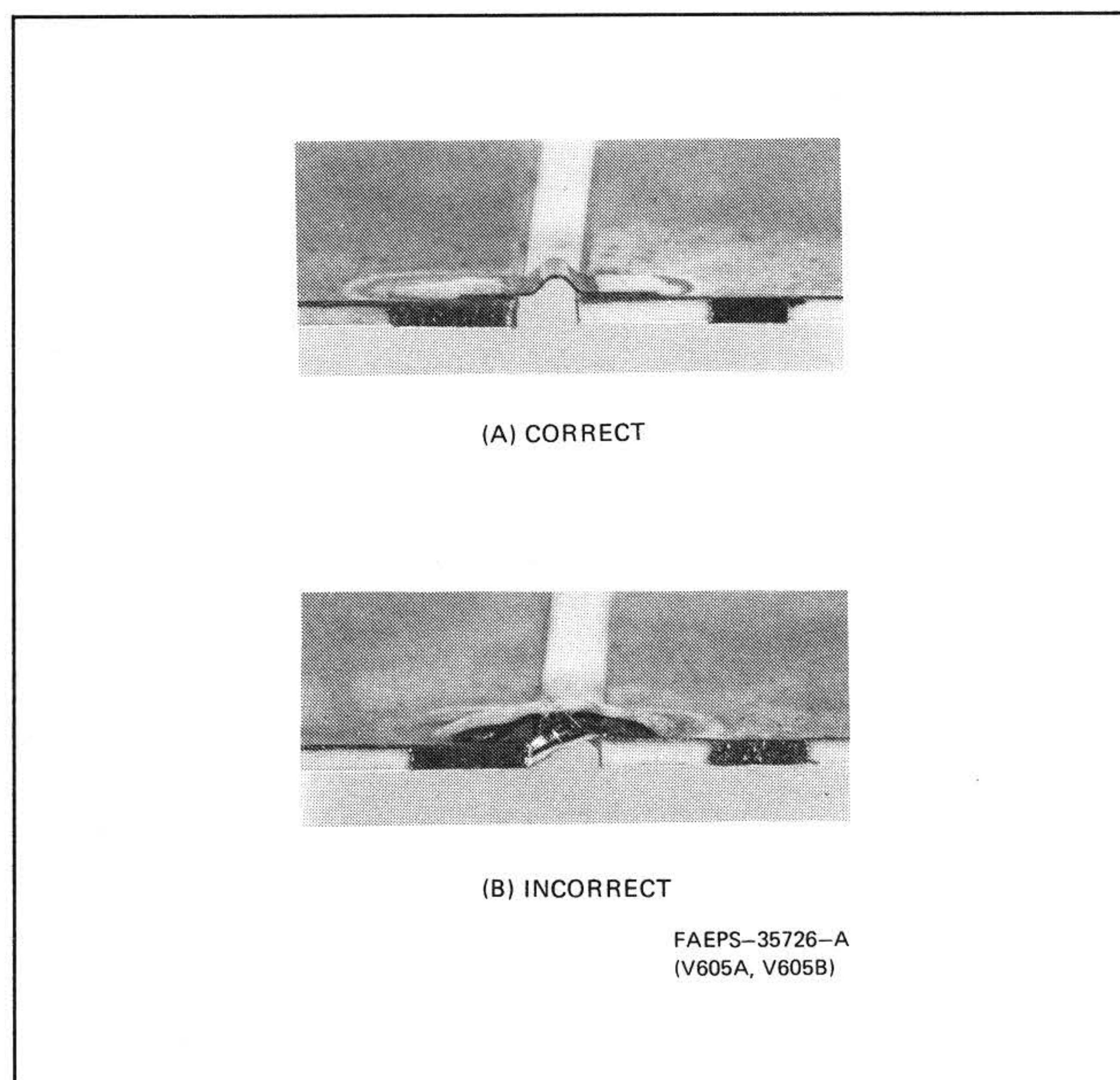
CAUTION

Installation of JU1 allows the transmitter to continue to operate, although a potentially damaging condition may exist. Therefore, key the transmitter for only short periods during servicing. Refer to the troubleshooting chart for fault isolation.

IMPORTANT

If the radio is a MSF digital style radio, refer to the Operation section of the installation manual. Under the "Special Service Modes" section is the procedure to enable/disable service jumper JU1 functionality. Follow all safeguards associated with JU1 usage.

3.1.3 Care should be exercised in removal of the "Omega" straps between modules and their reinstallation. Care should be exercised when soldering the "Omega" strap interconnects. The "Omega" straps (Motorola p/n 4284510M04) absorb mechanical stresses caused during temperature excursions of the station and therefore must remain flexible after installation. When soldering these connections, do not allow solder to bridge over the top or to fill the underside of the "Omega" strap. Figure 2a shows how a correctly soldered "Omega" strap should look. Incorrect soldering is shown in Figure 2b. Furthermore, do not substitute any rigid material or attempt to replace an "Omega" strap by "solder bridging". If proper soldering techniques are not observed during installation of "Omega" straps, premature failure of the hybrid module can result.



*Figure 2.
"Omega" Strap Replacement Soldering Technique*

IMPORTANT

Power measurements of the individual final power amplifier deck modules should *not* be attempted. The splitter and combiner circuits serve to prevent imbalances in drive and output of the final amplifier stages. If input or output connections to the individual final modules are broken, power measurements will be incorrect.

3.2 MODULE REPLACEMENT PROCEDURE

The rf power modules consist of an rf power transistor and associated circuits that are secured by screws to a copper heat spreader.

Step 1. Locate the defective module (refer to the power amplifier deck troubleshooting procedures).

Step 2. Disconnect the power from the deck to be repaired.

Step 3. Unsolder all four "Omega" straps from the module to be replaced from the adjacent circuit boards. Also unsolder the A + and all of the ground straps from the module circuit board.

Step 4. Remove the two outside screws holding the module to the heat sink.

Step 5. Remove the module. Thermal compound between the module and the heat sink may cause the mod-

ule to stick to the heat sink. A gentle "rocking" force is usually sufficient to free a stuck module.

Step 6. Apply a thin coat of new thermal compound between the module and the heat sink in the module location.

Step 7. Position the new module on the heat sink, ensuring the module is oriented properly.

Step 8. Carefully replace the two screws holding the module to the heat sink.

Step 9. Solder all "Omega" straps to adjacent circuit boards. Refer to paragraph 3.1.3 for the proper "Omega" strap soldering technique. Also, solder the A+ connection and all the ground straps to the module circuit board. Reconnect power to the deck.

CAUTION

The PA deck requires connection to a 28 V ganged supply. Make sure that both 28 V supplies are connected together. Failure to have this connection could result in overheating of power supply.

3.3 COMBINER BOARD REMOVAL PROCEDURE

Step 1. Remove the FPA deck cover (4 screws).

Step 2. Unsolder the isolation resistor leads from the combiner board.

IMPORTANT

At this time the isolation resistors should be checked for resistance value. Refer to paragraph 3.7 for the isolation resistor test procedure.

Step 3. Unsolder all "Omega" strap connections between the combiner boards and all modules. Also, unsolder all ground strap connections from the combiner board. Unsolder the directional coupler connection if removing the combiner connected to the rf output connector.

Step 4. Remove the board from the heat sink.

3.4 COMBINER BOARD INSTALLATION PROCEDURE

Step 1. Position the combiner board on the heat sink ensuring that all module "Omega" straps lie on top of the board and that all isolation resistor leads are aligned to protrude through the proper board holes.

Step 2. Solder all "Omega" straps from the modules from the adjacent circuit boards to the combiner board. Also solder all ground strap connections to the combiner board and the directional coupler connection if replacing the combiner connected to the rf output connector.

Step 3. Solder all the isolation resistor leads to the combiner board.

Step 4. Re-install the FPA cover (4 screws).

3.5 SPLITTER BOARD REMOVAL PROCEDURE

The splitter board removal procedure is identical to the combiner board removal procedure.

3.6 SPLITTER BOARD INSTALLATION PROCEDURE

The splitter board installation procedure is identical to the combiner board installation procedure.

3.7 ISOLATION RESISTOR TEST AND REPLACEMENT PROCEDURE

Step 1. Unsolder all leads of the isolation resistor to be tested from the appropriate splitter or combiner board.

Step 2. Measure the resistance on all combinations of any two leads of the isolation resistor (one measurement on the two-way resistor TRN7065A; three measurements on the three-way resistor TRN5207A). Resistance should measure between 90 and 110 ohms for both the TRN5207A and TRN7065A.

Step 3. Resolder the isolation resistor to the board if it is not found to be defective, otherwise replace it.

FPA TROUBLESHOOTING PREREQUISITES

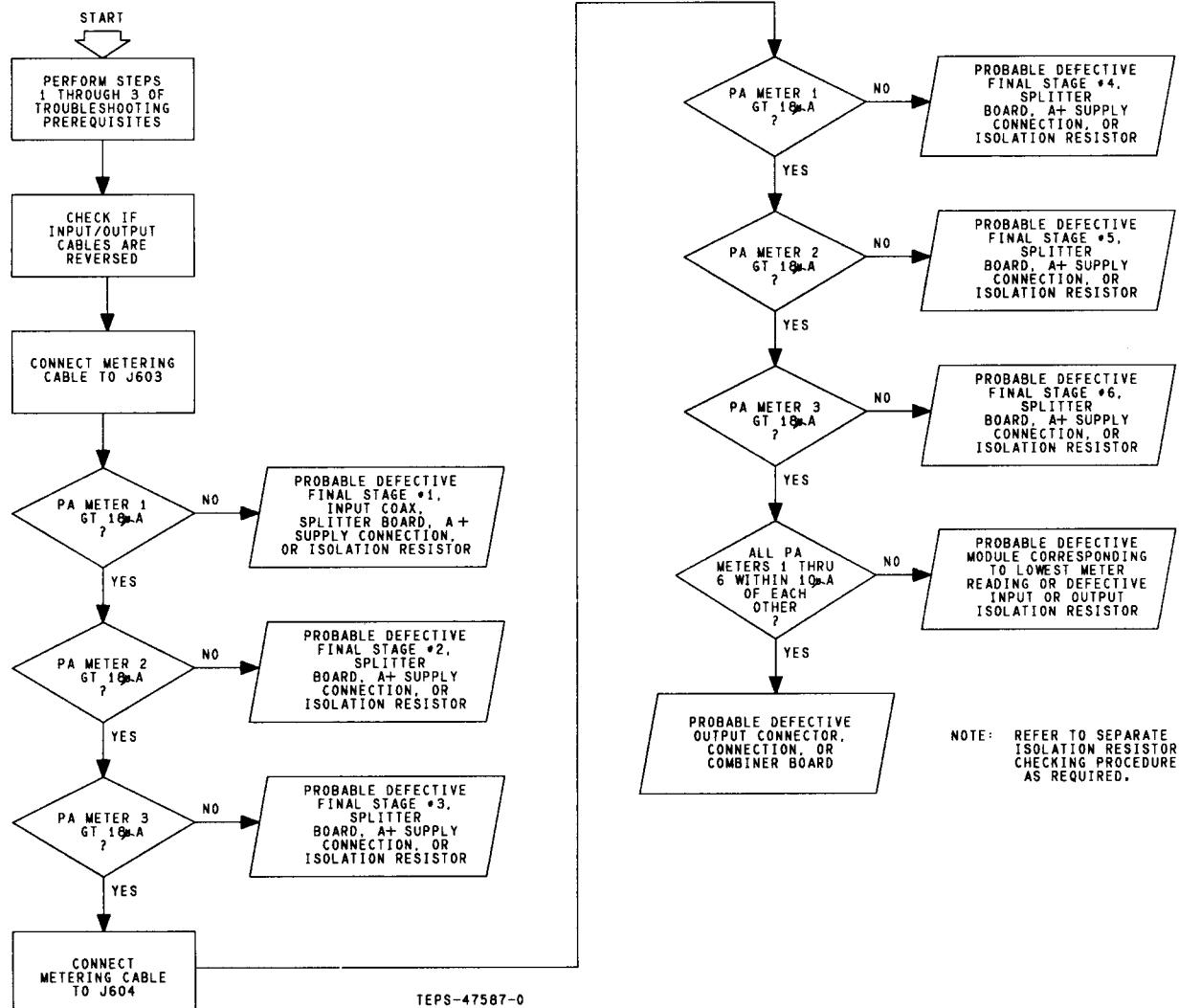
STEP 1. INSTALL STATION CONTROL BOARD SERVICE JUMPER (JU1) ONTO ITS SERVICE INSTALLATION POSITION.

IMPORTANT

IF THE RADIO IS A MSF DIGITAL STYLE RADIO, REFER TO THE OPERATION SECTION. UNDER THE SPECIAL SERVICE MODES SECTION IS THE PROCEDURE TO ENABLE/DISABLE SERVICE JUMPER JU1 FUNCTIONALITY. FOLLOW ALL SAFEGUARDS ASSOCIATED WITH JU1 USAGE. WHEN TROUBLESHOOTING IS COMPLETED, RETURN JU1 TO ITS ORIGINAL POSITION.

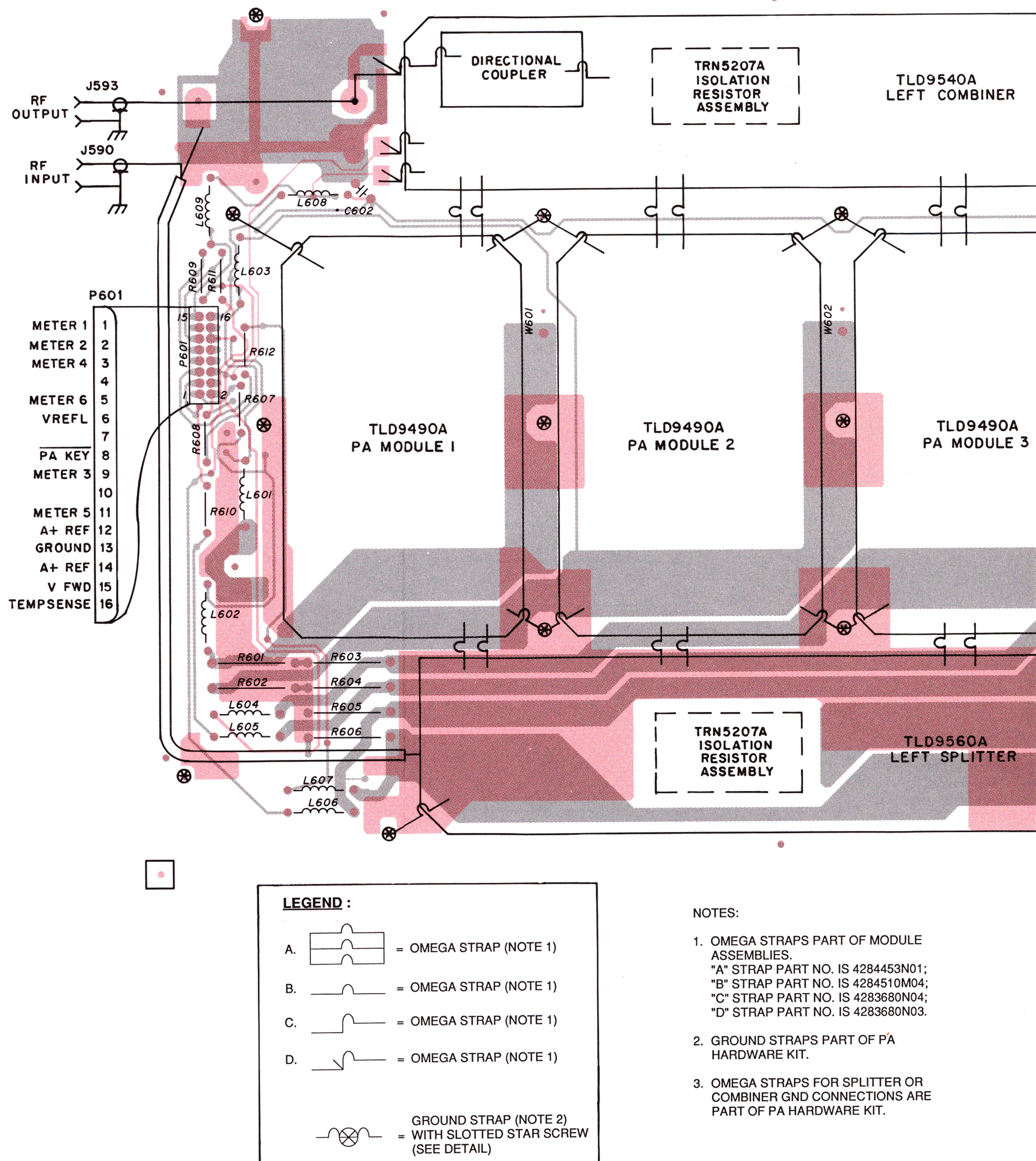
STEP 2. CONNECT THE FPA OUTPUT TO A WATTMETER TERMINATED IN A 50-OHM LOAD. BE SURE THE WATTMETER AND LOAD ARE RATED FOR USE AT 100-200 MHZ. MAKE SURE THE LOAD CAN HANDLE 500 W.

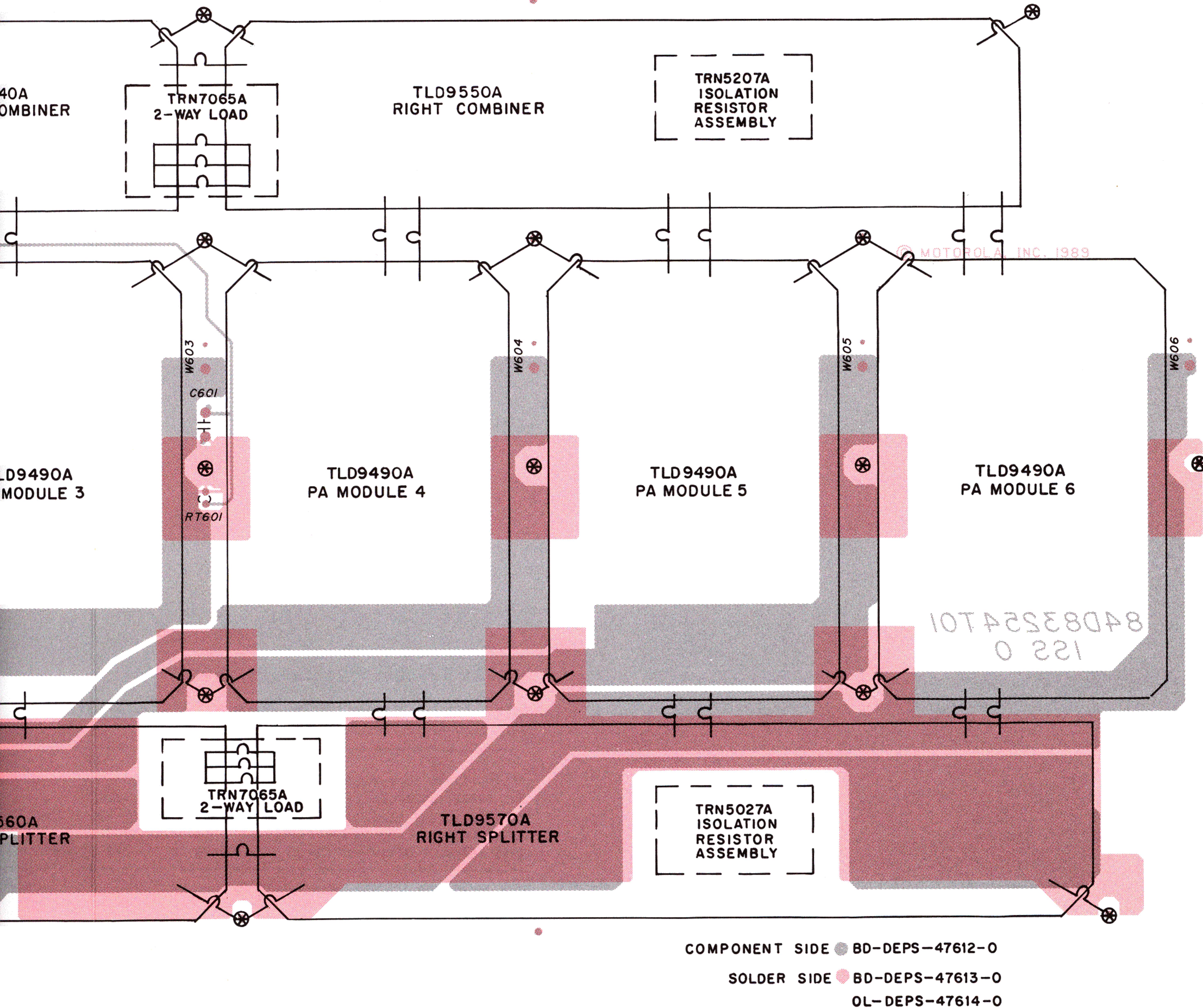
FINAL POWER AMPLIFIER DECK TROUBLESHOOTING CHART



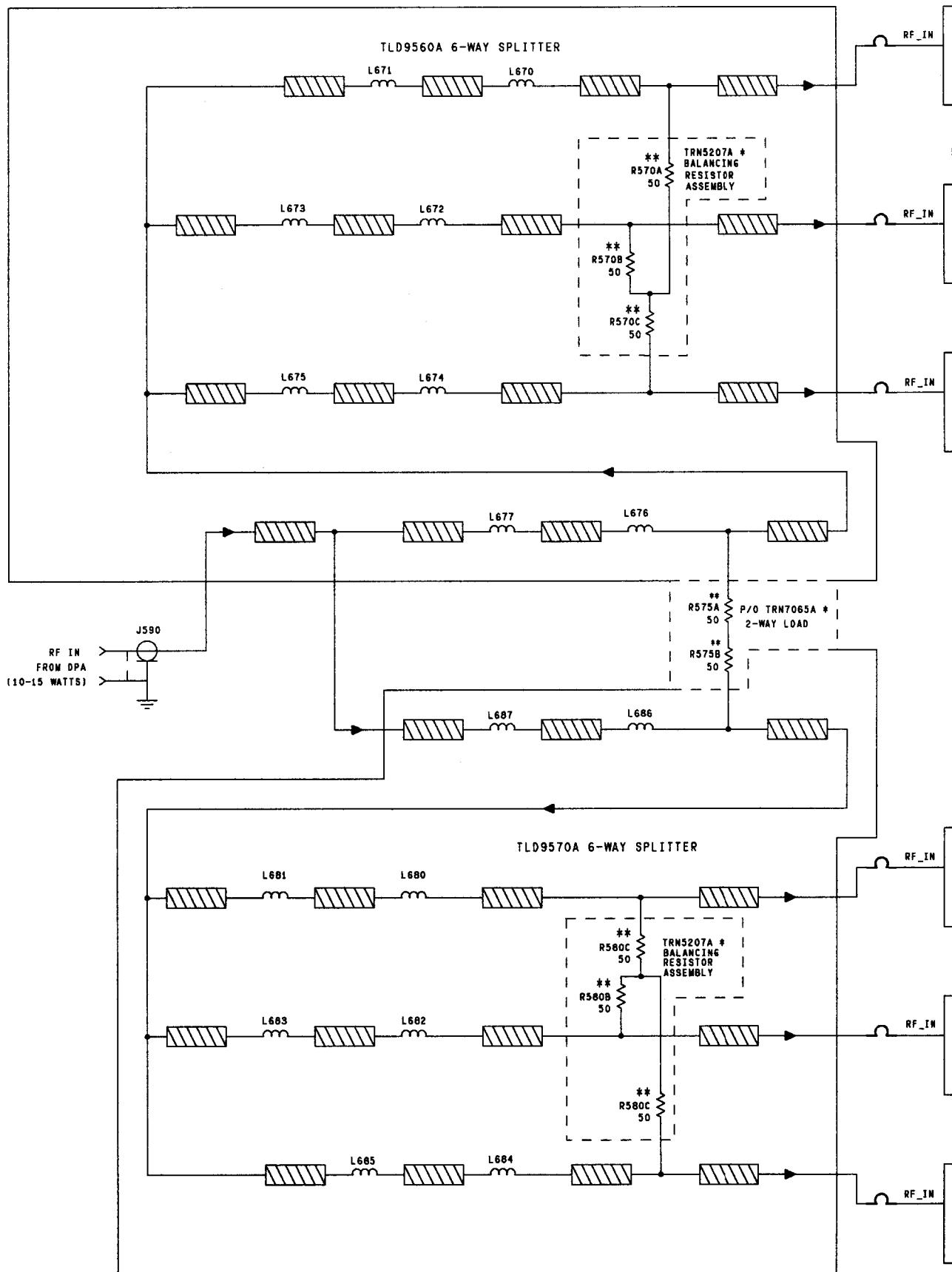
FINAL POWER AMPLIFIER DECK

CIRCUIT BOARD DETAIL



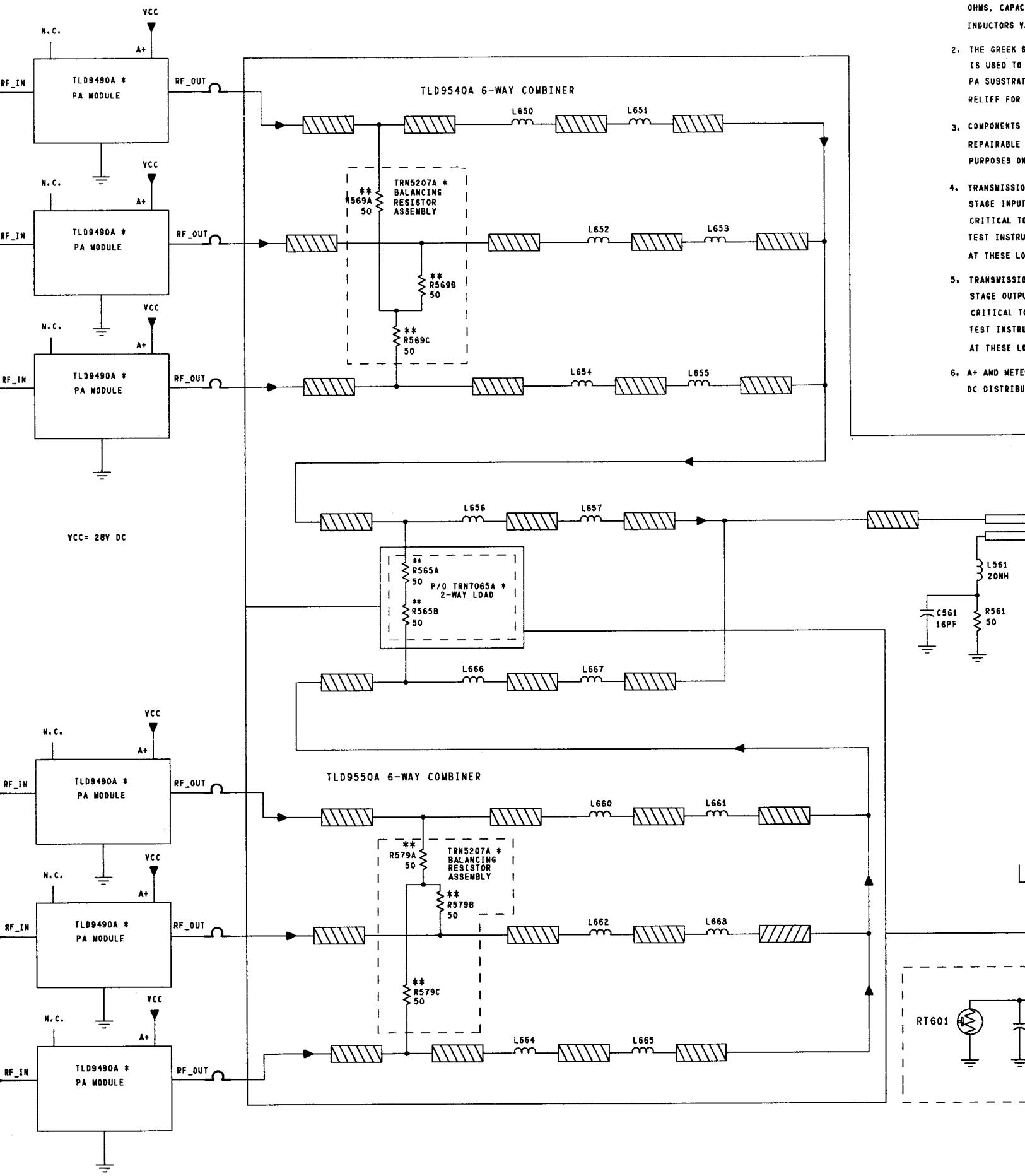


SHOWN FROM COMPONENT SIDE



NOTES:

1. UNLESS OTHERWISE SPECIFIED, UNITS ARE OHMS, CAPACITANCE IN FARADS, AND INDUCTORS IN HENRIES.
2. THE GREEK SYMBOL Ω IS USED TO INDICATE THAT THE PA SUBSTRATE HAS A RELIEF FOR THE BALANCING RESISTOR.
3. COMPONENTS IDENTIFIED BY A DASHED LINE ARE REPAIRABLE AND ARE FOR MAINTENANCE PURPOSES ONLY.
4. TRANSMISSION STAGE INPUTS ARE CRITICAL TO TEST INSTRUMENTATION AT THESE LOCATIONS.
5. TRANSMISSION STAGE OUTPUTS ARE CRITICAL TO TEST INSTRUMENTATION AT THESE LOCATIONS.
6. A+ AND METERING POINTS ARE DC DISTRIBUTION POINTS.



FINAL POWER AMPLIFIER DECK

SCHEMATIC DIAGRAM

OTHERWISE SPECIFIED RESISTOR VALUES ARE IN
CAPACITOR VALUES ARE IN PICOFARADS, AND
INDUCTORS VALUES ARE IN HENRIES.

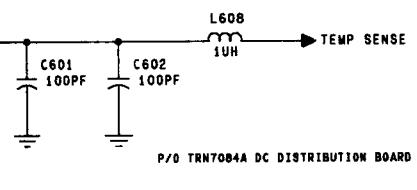
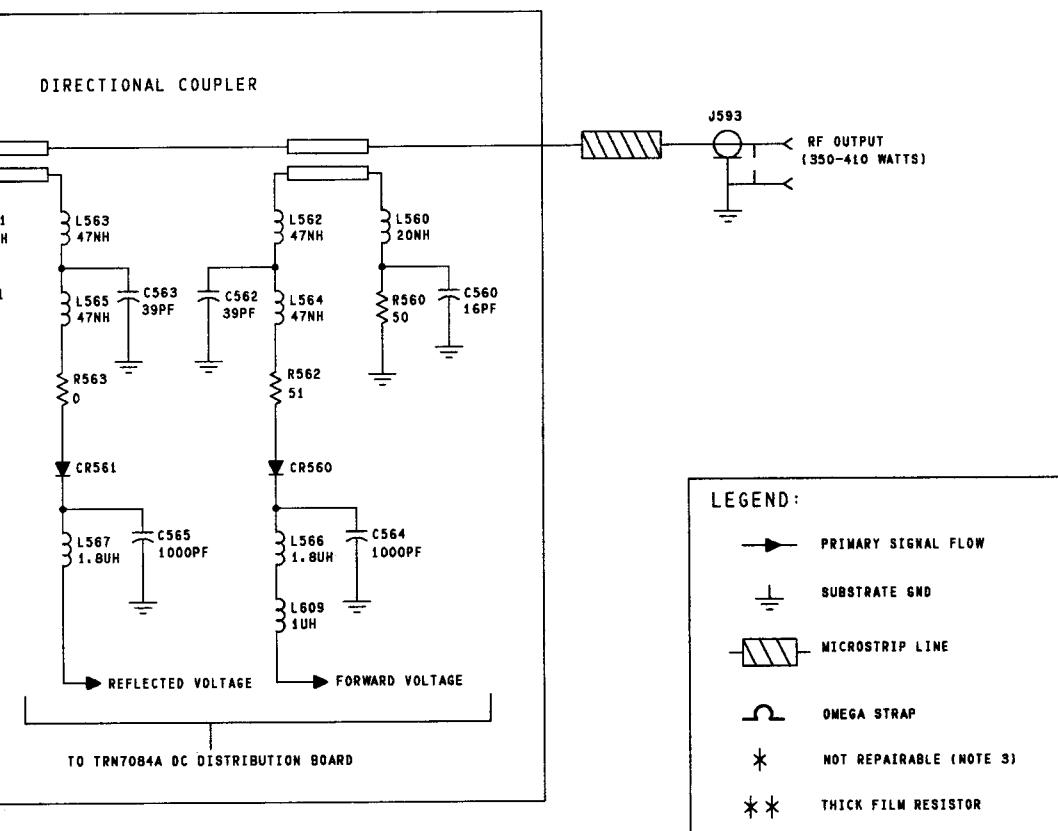
WEEK SYMBOL (---) DENOTES AN 'OMEGA STRAP' WHICH
IS USED TO PROVIDE CIRCUIT CONNECTIONS BETWEEN THE
SUBSTRATES AND PROVIDE THE NECESSARY STRAIN
FOR THERMAL EXPANSION AND CONTRACTION.

COMPONENTS MARKED WITH AN ASTERISK (*) ARE NOT
REPAIRABLE AND ARE SHOWN FOR REFERENCE
PURPOSES ONLY.

MISSION LINE LENGTHS BETWEEN THE POWER SPLITTER
INPUTS AND FINAL AMPLIFIER STAGE OUTPUTS ARE
CRITICAL TO PROPER AMPLIFIER OPERATION. DO NOT INSERT
TEST INSTRUMENTS (WATTMETER, LOAD TERMINATION, ETC.)
IN THESE LOCATIONS.

MISSION LINE LENGTHS BETWEEN THE POWER COMBINER
OUTPUTS AND FINAL AMPLIFIER STAGE INPUTS ARE
CRITICAL TO PROPER AMPLIFIER OPERATION. DO NOT INSERT
TEST INSTRUMENTS (WATTMETER, LOAD TERMINATION, ETC.)
IN THESE LOCATIONS.

METERING CONNECTIONS ARE MADE VIA THE TRN7084A
DC DISTRIBUTION BOARD.



TEPS-47588-0

FINAL POWER AMPLIFIER DECK

SCHEMATIC DIAGRAM, CIRCUIT BOARD DETAIL AND PARTS LISTS

parts list

TRN7084A DC Distribution Board

PL-11363-A

REFERENCE SYMBOL	MOTOROLA PART NO.	DESCRIPTION
C601,602	2111022A55	capacitor, fixed: 100pF ± 5%; 50V
L601thru 609	2482835G14	coil: 1uH
P601	0984865R06	connector: receptacle: 16-contact
R601 thru 606	1782620B04	resistor, fixed: .02 ± 3%; 3W
R607 thru 612	0611009C56	2000 ± 5%; 1/4W
RT601	0683800K05	thermistor: (see note) 100K

TLD9490A Module PA VHF

PL-11490-O

REFERENCE SYMBOL	MOTOROLA PART NO.	DESCRIPTION
C571	2111078B42	capacitor, fixed: pF ± 5% 50V unless otherwise stated 100 100V
C572	2113740B41	47
C573	2113740B21	6.8 ± 0.25pF
C574	2184366F32	100 ± 10% 250V
C575	2311049A17	6.8uF ± 10% 35V
C576,577	2113740B73	1000
C578,579	2113740B58	200
C580	2113741B45	.01uF
C581 thru 583	2113740B73	1000
C584	2184366F38	330 150V
CR571	4880140L07	diode: (see note) Zener: 5.6V
CR572	4882106T01	Schottky
L571	2483035N14	coil: 4 turns
L572,573	2411087A29	1.8uH
L574	2484331M44	3 turns
L575,576	2484331M42	11 turns
Q571	4882233P80	transistor: (see note) silicon
R571 thru 574	0611077A76	resistor, fixed: ± 5% 1/8W unless otherwise stated
R575,576	0611077A43	1.2k
R577	0611077A98	51
R579	0611077B17	10k
R580,581	0611077A71	56k
R582,583	0611077A72	750
RT571	0680149M02	820
		thermistor: 100k ± 10% 240mW
		non-referenced items
	0310943J10	SCREW, tapping: TT3 × 0.5; 2 used
	2983208M01	LUG, solder: 2 used
	4284510M04	STRAP, power amplifier: 4 used
	8482287N01	PLATE, ground strip: 2 used
	8483530T01	PLATE, transistor mounting

note: For optimum performance, diodes, transistors, and integrated circuits must be ordered by Motorola part numbers.

TLD9570A Right 6-Way Splitter

PL-11360-A

REFERENCE SYMBOL	MOTOROLA PART NO.	DESCRIPTION
L680	2483035N60	coil, rf: 5 turns
L681	2483035N59	4 turns
L682	2483035N60	5 turns
L683	2483035N59	4 turns
L684	2483035N60	5 turns
L685	2483035N59	4 turns
L686	2483035N68	3 turns
L687	2483035N69	4 turns

TRN9961A Interconnect Board

PL-11134-O

REFERENCE SYMBOL	MOTOROLA PART NO.	DESCRIPTION
P602	0984865R06	connector: receptacle: 16-contact
P603, 604	0983365N01	receptacle: 8-contact
P605	2810773A05	plug: 10-contact

TRN5207A Balancing Resistor Kit

PL-8255-O

REFERENCE SYMBOL	MOTOROLA PART NO.	DESCRIPTION
	7-83108N01	BRACKET, resistor
	7-84102N01	FRAME, LD

TKN8549A PA DC Power Cable

PL-11292-O

REFERENCE SYMBOL	MOTOROLA PART NO.	DESCRIPTION
E561	2983897M02	terminal: terminal, wire grip
W502	3000831572	cable: #10 gauge stranded black battery: 9.5"
W503	3000813233	#10 gauge stranded red battery: 8.5"
		non-referenced item
	2982907N05	TERMINAL, ring: yellow

TRN7113A 350W PA Hardware

PL-11384-A

REFERENCE SYMBOL	MOTOROLA PART NO.	DESCRIPTION
	0182691T02	PLATE, feedthru
	0182722T01	CABLE, metering board
	0310943J10	SCREW, tapping: TT3 × 0.5 × 8 (10 used)
	0310943J21	SCREW, tapping: TT4 × 0.7 × 10 (8 used)
	0310943R68	SCREW, tapping: TT4 × 0.7 × 13 (2 used)
	0383498N06	SCREW, tapping: M4 × 0.7 × 16 (16 used)
	0383678N02	SCREW, tapping: M4 × 0.7 × 18 (4 used)
	0383678N03	SCREW, tapping: M3 × 0.5 × 9 (39 used)
	0400007607	WASHER, flat: 0.125 × .281 × .027 (4 used)
	0400007657	WASHER, lock: No. 8 ext tooth
	0400139423	WASHER, flat: 0.125 × 0.218 × .018" (15 used)
	0780078A01	BRACKET, thermistor mtg
	0783990P01	BRACKET, PA mtg, RH
	0783990P03	BRACKET, PA mtg, LH
	0900816159	CONNECTOR, receptacle (2 used)
	1582584T01	COVER, PA pocket
	1583177N01	COVER, PA
	2683223T01	HEAT SINK, power amplifier
	2683379T01	HEAT SINK, combiner cooling
	3082616T01	CABLE, rf, Input
	3282796H02	GASKET: 49.25" lg
	3282796H03	GASKET: 8.75" lg
	4210217A02	STRAP, tie: .091 × 3.62"
	4283150N01	STRAP, grounding (15 used)
	4283680N03	STRAP, IPA (3 used)
	4283680N04	STRAP, interconnect (4 used)
	4284453N01	STRAP, triple PA (2 Used)
	4284510M04	STRAP, PA (2 used)

PL-11360-A

DESCRIPTION
coil, rf:
5 turns
4 turns
5 turns
4 turns
5 turns
4 turns
3 turns
4 turns

PL-11134-O

DESCRIPTION
connector:
receptacle: 16-contact
receptacle: 8-contact
plug:10-contact

PL-8255-O

DESCRIPTION
BRACKET, resistor FRAME, LD

PL-11292-O

DESCRIPTION
terminal: terminal, wire grip
cable: #10 gauge stranded black battery: 9.5" #10 gauge stranded red battery: 8.5"
referenced item
TERMINAL, ring: yellow

PL-11364-A

DESCRIPTION
PLATE, feedthru
CABLE, metering board
SCREW, tapping: TT3 x 0.5 x 8 (10 used)
SCREW, tapping: TT4 x 0.7 x 10 (8 used)
SCREW, tapping: TT4 x 0.7 x 13 (2 used)
SCREW, tapping: M4 x 0.7 x 16 (16 used)
SCREW, tapping: M4 x 0.7 x 18 (4 used)
SCREW, tapping: M3 x 0.5 x 9 (39 used)
WASHER, flat: 0.125 x .281 x .027 (4 used)
WASHER, lock: No. 8 ext tooth
WASHER, flat: 0.125 x 0.218 x .018" (15 used)
BRACKET, thermistor mtg
BRACKET, PA mtg, RH
BRACKET, PA mtg, LH
CONNECTOR, receptacle (2 used)
COVER, PA pocket
COVER, PA
HEAT SINK, power amplifier
HEAT SINK, combiner cooling
CABLE, rf, Input
GASKET: 49.25" lg
GASKET: 8.75" lg
STRAP, tie: .091 x 3.62"
STRAP, grounding (15 used)
STRAP, IPA (3 used)
STRAP, Interconnect (4 used)
STRAP, triple PA (2 Used)
STRAP, PA (2 used)

TLD9560A Left 6-Way Splitter

PL-11359-A

REFERENCE SYMBOL	MOTOROLA PART NO.	DESCRIPTION
L670	2483035N60	coil, rf:
L671	2483035N59	5 turns
L672	2483035N60	4 turns
L673	2483035N59	5 turns
L674	2483035N60	4 turns
L675	2483035N59	5 turns
L676	2483035N68	3 turns
L677	2483035N67	4 turns

TRN7065A Hybrid Isolation Load, 2-Way

PL-11294-O

REFERENCE SYMBOL	MOTOROLA PART NO.	DESCRIPTION
0783108N01		BRACKET, resistor
0784102N01		FRAME, low density

TLD9540A Left 6-Way Combiner

PL-11357-A

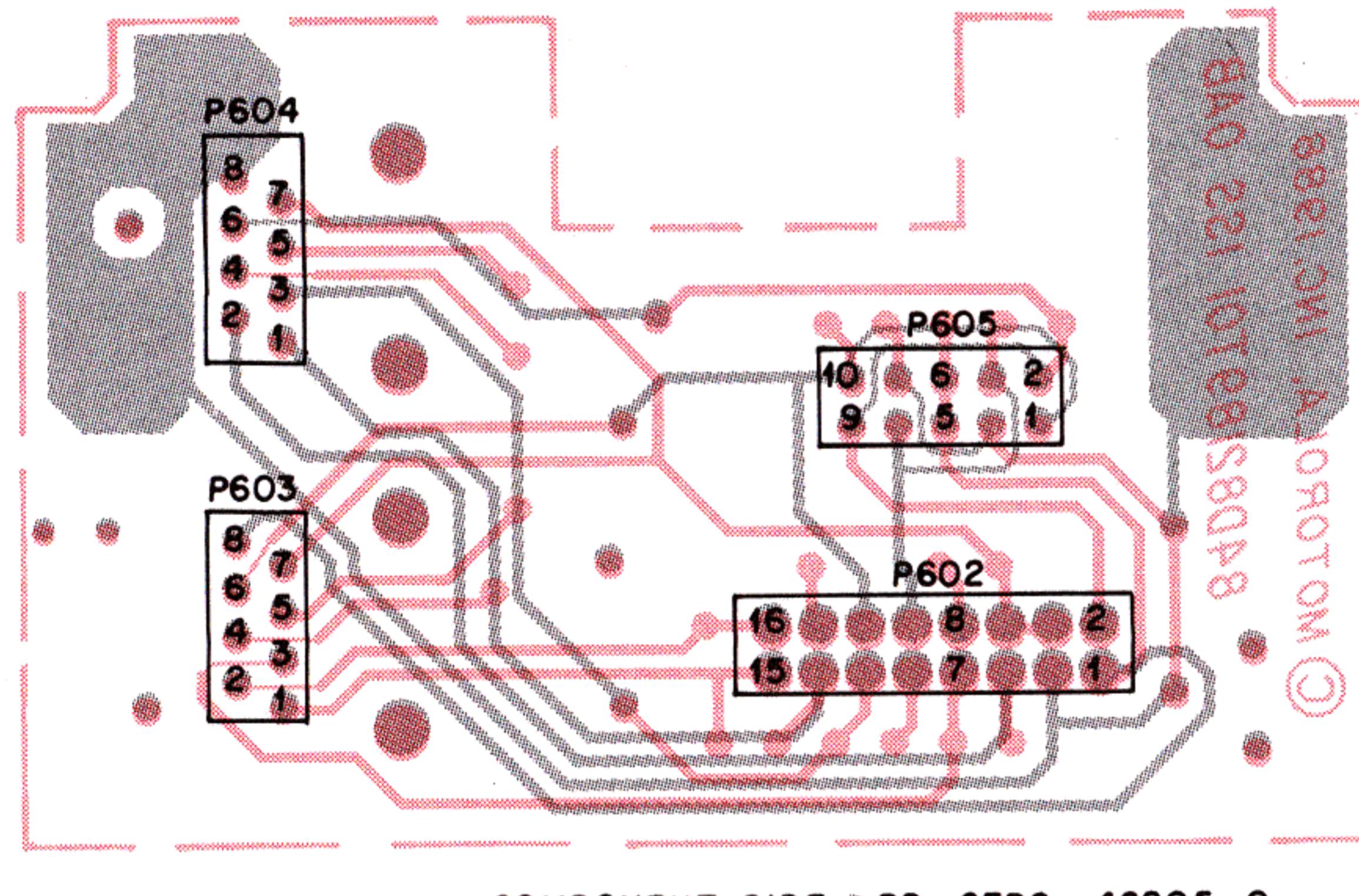
REFERENCE SYMBOL	MOTOROLA PART NO.	DESCRIPTION
C560,561	2113740B25	capacitor, fixed: pF ± 5%; 50V:
C562,563	2113740B39	10
C564,565	2113740B73	39
CR560,561	4882106T01	1000
		diode: (see note) Schottky type
L560,561	2483035N32	coil:
L562 thru 565	2483035N26	7 turns
L566,567	2411087A29	8 turns
L650	2483035N60	1.8uH
L651	2483035N59	5 turns
L652	2483035N60	4 turns
L653	2483035N59	5 turns
L654	2483035N60	4 turns
L655	2483035N59	5 turns
L656	2483035N68	3 turns
L657	2483035N67	4 turns
R560,561	0683854P02	resistor, fixed: 50 ± 2%; 1W

TLD9550A Right 6-Way Combiner

PL-11358-O

REFERENCE SYMBOL	MOTOROLA PART NO.	DESCRIPTION
L680	2483035N60	coil, rf:
L681	2483035N59	5 turns
L682	2483035N60	4 turns
L683	2483035N59	5 turns
L684	2483035N60	4 turns
L685	2483035N59	5 turns
L686	2483035N68	3 turns
L687	2483035N67	4 turns

TRN9961A INTERCONNECT POCKET BOARD



COMPONENT SIDE BD-CEPS-46205-0
SOLDER SIDE BD-CEPS-46206-0
OL-CEPS-47596-0

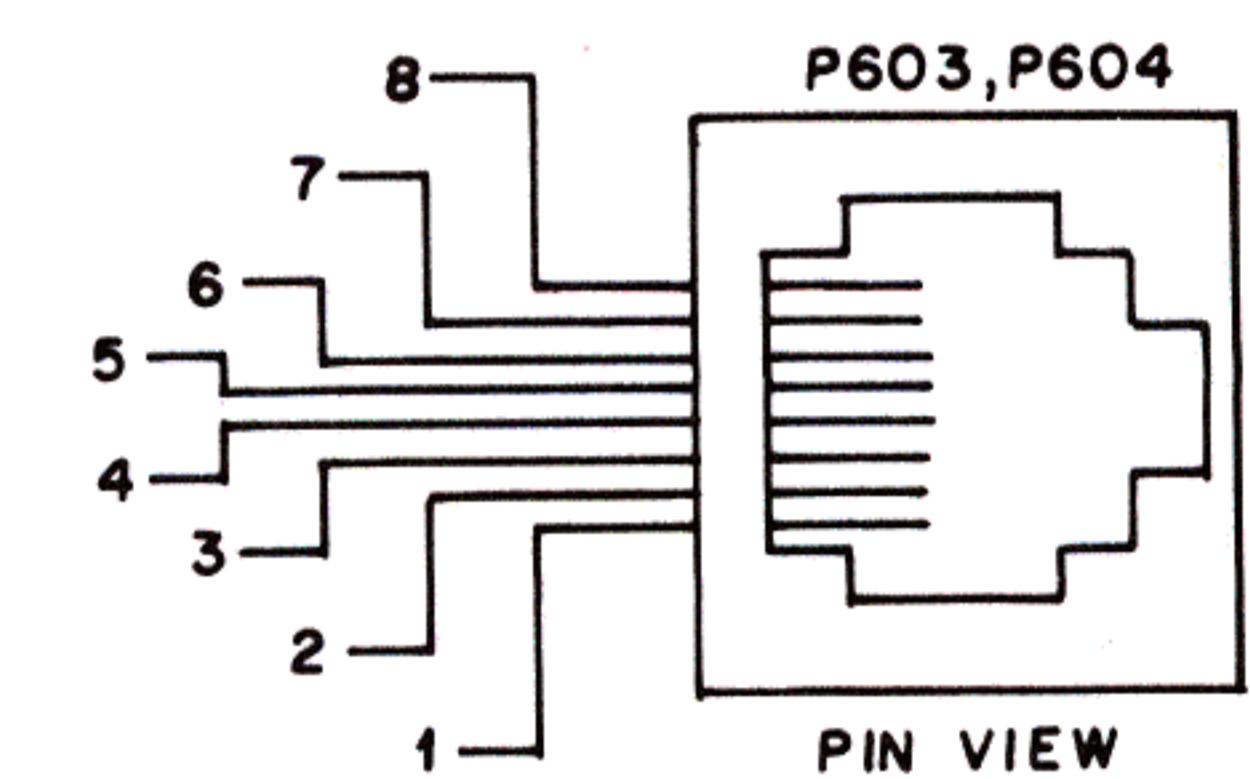
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P605		THERMISTOR
VREV	2	1
GND	4	3 PA KEY
V FWD	6	5 V FWD
PA KEY	8	7 GND
THERMISTOR	10	9 VREV

PIN VIEW

P602		PA METERING
THERMISTOR	2	V FWD
A+ REF	4	GND
A+ REF	6	METER 5
NOT USED	8	METER 3
N.C.	10	N.C.
VREV	12	METER 6
N.C.	14	METER 4
METER 2	16	METER 1

PIN VIEW

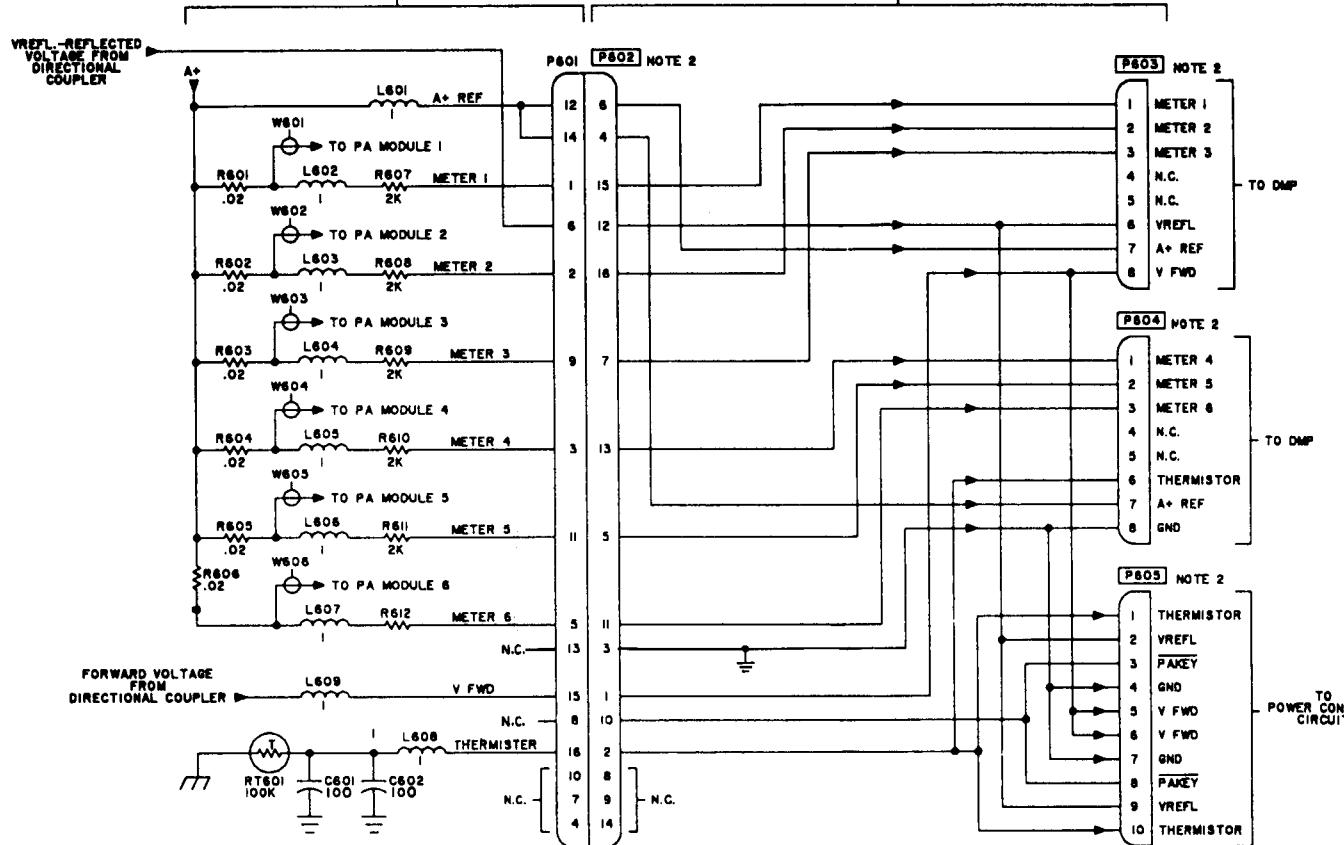


PIN	P603	P604
1	METER 1	METER 4
2	METER 2	METER 5
3	METER 3	METER 6
4	NOT USED	NOT USED
5	NOT USED	NOT USED
6	V REV	THERMISTOR
7	A+ REF	A+ REF
8	V FWD	GND

NOTE: METER 3,4,5,6 NOT USED WITH TLD2690A P.A. DECK.

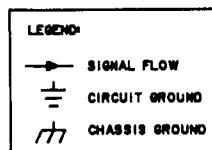
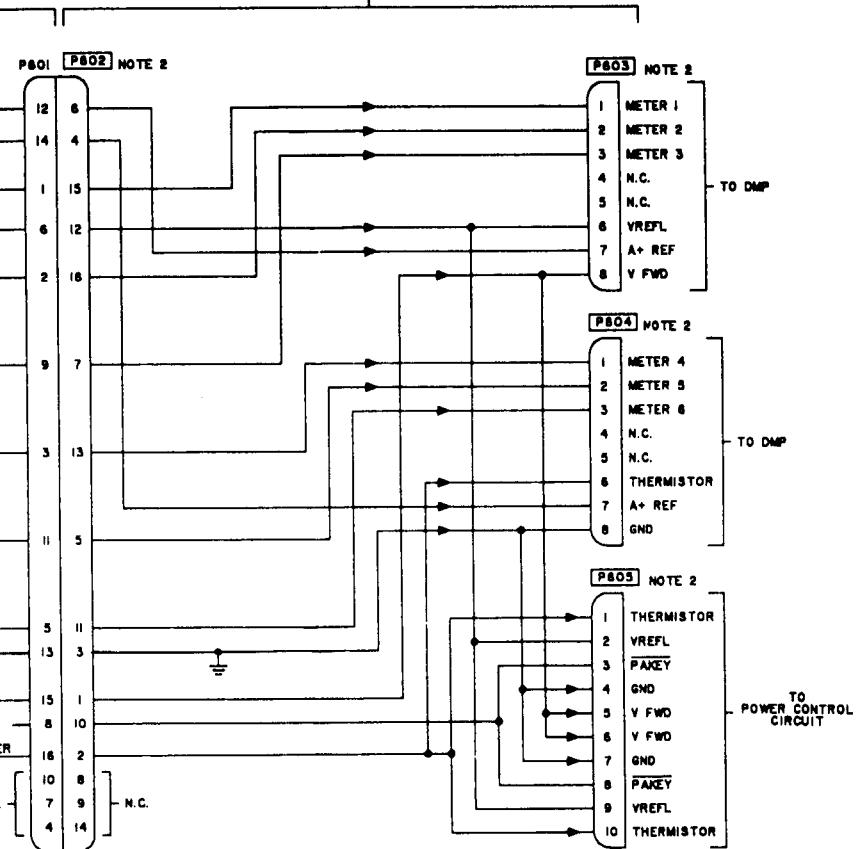
TRN7084A DC DISTRIBUTION BOARD

TRN9961A INTERCONNECT BOARD



BOARD

TRN9961A INTERCONNECT BOARD



NOTES:

1. UNLESS OTHERWISE SPECIFIED, ALL RESISTOR VALUES ARE IN OHMS, ALL CAPACITOR VALUES ARE IN PICO-FARADS AND ALL INDUCTOR VALUES ARE IN MICROHENRIES.
2. CONNECTORS P602, P603, P604, AND P605 ARE JACKS MOUNTED ON THE TRN9961A INTERCONNECT BOARD.

DEPS-47611-0